

PHOTOCOUPLER **PS2815-1,PS2815-4**

LOW (AC) INPUT CURRENT, HIGH CTR 4, 16-PIN SSOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2815-1 and PS2815-4 are optically coupled isolators containing GaAs light emitting diodes and an NPN silicon phototransistor in a plastic SSOP for high density applications.

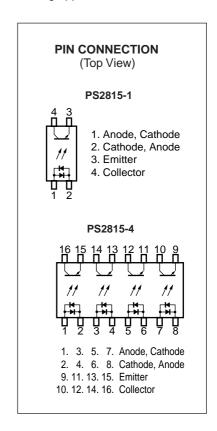
The package is a Small SOP (Small Outline Package) type for high density mounting applications.

FEATURES

- · AC input response
- High current transfer ratio (CTR = 200% TYP. @ I_F = ±1 mA)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4, 16-pin SSOP, Pin pitch 1.27 mm)
- Ordering number of tape product: PS2815-1-F3, F4, PS2815-4-F3, F4
- ★ Pb-Free product
- Safety standards: PS2815-1, -4
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

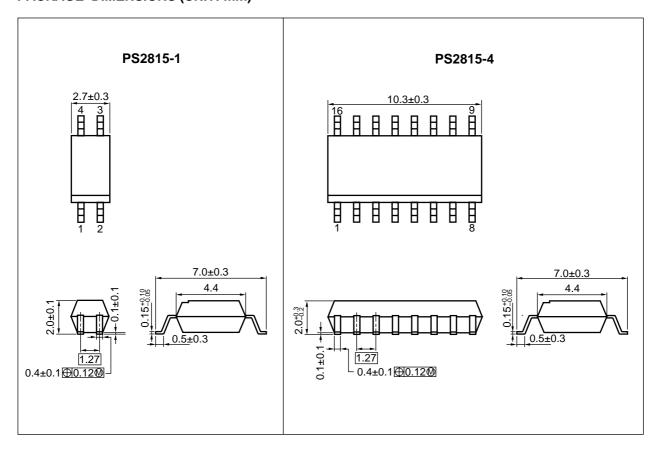
APPLICATIONS

- · Programmable logic controllers
- Modem/FAX

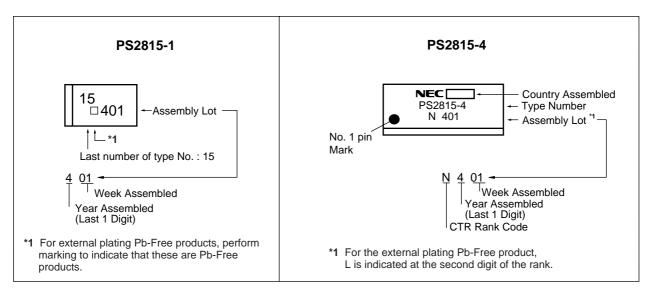


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PACKAGE DIMENSIONS (UNIT: mm)



★ MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
PS2815-1	PS2815-1	Solder	50 pcs (Tape 50 pcs cut)	Standard products	PS2815-1
PS2815-1-F3	PS2815-1-F3	contains lead	Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2815-1-F4	PS2815-1-F4				
PS2815-1-V	PS2815-1-V		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2815-1-V-F3	PS2815-1-V-F3		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2815-1-V-F4	PS2815-1-V-F4			Approved (Option)	
PS2815-4	PS2815-4		Magazine Case 45 pcs	Standard products	PS2815-4
PS2815-4-F3	PS2815-4-F3		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS2815-4-F4	PS2815-4-F4				
PS2815-4-V	PS2815-4-V		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2815-4-V-F3	PS2815-4-V-F3		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2815-4-V-F4	PS2815-4-V-F4			Approved (Option)	
PS2815-1	PS2815-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2815-1
PS2815-1-F3	PS2815-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2815-1-F4	PS2815-1-F4-A				
PS2815-1-V	PS2815-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2815-1-V-F3	PS2815-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2815-1-V-F4	PS2815-1-V-F4-A			Approved (Option)	
PS2815-4	PS2815-4-A		Magazine Case 45 pcs	Standard products	PS2815-4
PS2815-4-F3	PS2815-4-F3-A		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS2815-4-F4	PS2815-4-F4-A				
PS2815-4-V	PS2815-4-V-A		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2815-4-V-F3	PS2815-4-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2815-4-V-F4	PS2815-4-V-F4-A			Approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (Unless otherwise specified, TA = 25°C)

Parameter		Symbol	Ratings		
			PS2815-1	PS2815-4	Unit
Diode	Forward Current (DC)	lF	±50		mA
	Power Dissipation Derating	⊿P₀/°C	0.6	0.7	mW/°C
	Power Dissipation	Po	60	70	mW/ch
	Peak Forward Current*1	rrent ^{*1} I _{FP} ±1.0		А	
Transistor	Collector to Emitter Voltage	Vceo	4	40	
	Emitter to Collector Voltage	Veco	ţ	5	V
	Collector Current	lc	4	.0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1	.2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage*2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		T _{stg}	−55 to +150		°C

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.

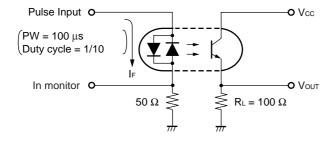
Pins 1-2 shorted together, 3-4 shorted together (PS2815-1).

Pins 1-8 shorted together, 9-16 shorted together (PS2815-4).

ELECTRICAL CHARACTERISTICS (TA = 25°C)

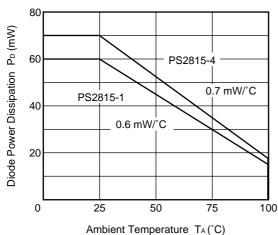
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.15	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Transistor	Collector to Emitter Dark Current	Iceo	IF = 0 mA, VcE = 40 V			100	nA
Coupled	Current Transfer Ratio	CTR	I _F = ±1 mA, V _{CE} = 5 V	100	200	400	%
	Collector Saturation Voltage	VCE (sat)	$I_F = \pm 1 \text{ mA}, I_C = 0.2 \text{ mA}$			0.3	V
	Isolation Resistance	R _I -o	Vi-o = 1 kVDC	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time ^{*1}	tr	$Vcc = 5 \text{ V, } Ic = 2 \text{ mA, } R_L = 100 \Omega$		4		μS
	Fall Time ^{*1}	t _f			5		

*1 Test circuit for switching time

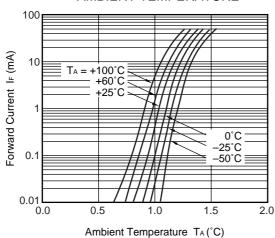


TYPICAL CHARACTERISTICS (Unless otherwise specified, TA = 25°C)

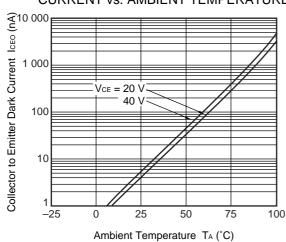




FORWARD CURRENT vs. AMBIENT TEMPERATURE

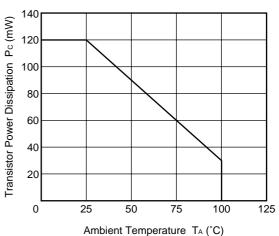


COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

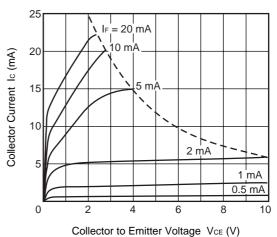


Remark The graphs indicate nominal characteristics.

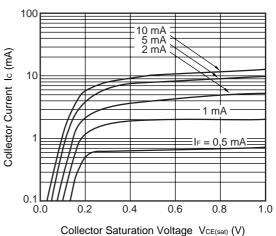
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**



COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**



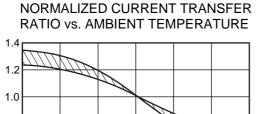
Normalized Current Transfer Ratio CTR

0.8

0.4

0.2

0.0



-25 0 25 50 75

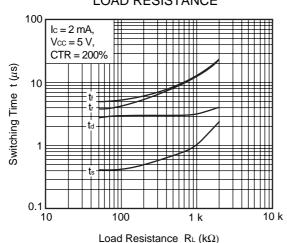
Ambient Temperature T_A (°C)

Normalized to 1.0

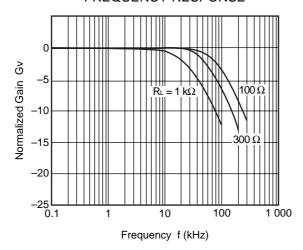
100

at $T_A = 25$ °C, If = 1 mA, $V_{CE} = 5$ V

SWITCHING TIME vs. LOAD RESISTANCE

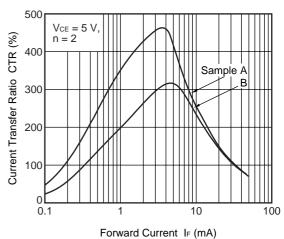


FREQUENCY RESPONSE

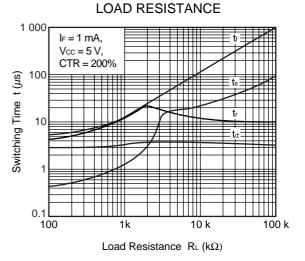


Remark The graphs indicate nominal characteristics.

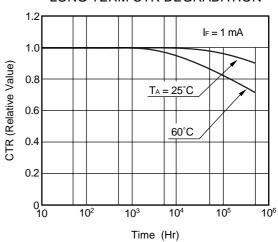
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



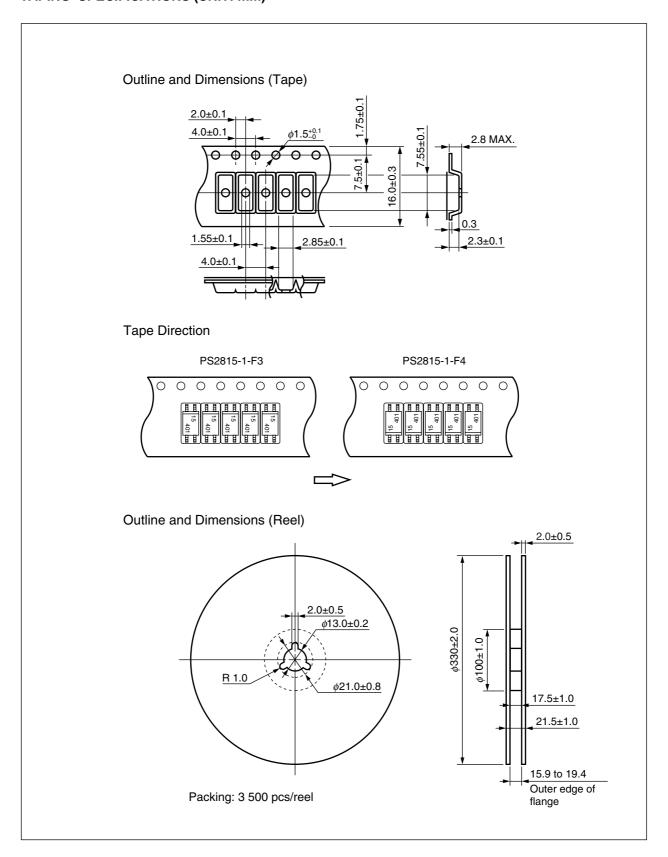
SWITCHING TIME vs.

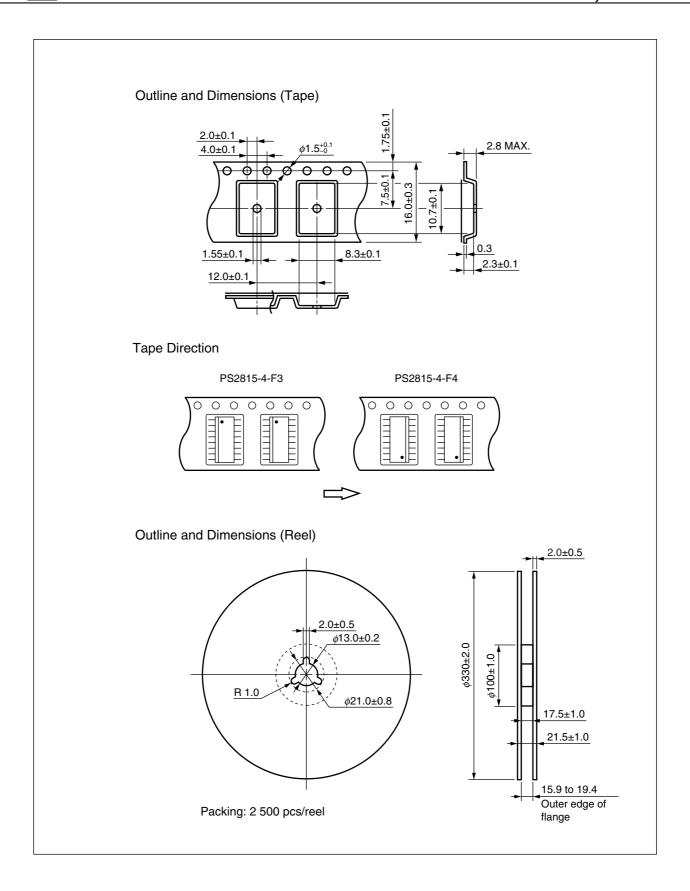


LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (UNIT: mm)





* NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

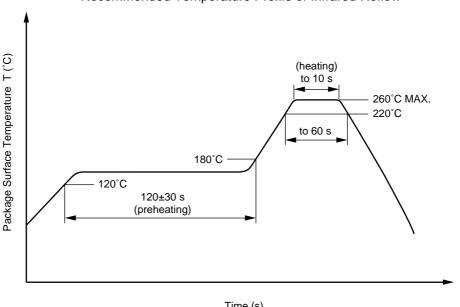
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

Peak temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices		
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)		
Mercury	< 1000 PPM	Not Detected			
Cadmium	lmium < 100 PPM		Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected			
PBB	< 1000 PPM	Not Detected			
PBDE	PBDE < 1000 PPM		Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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